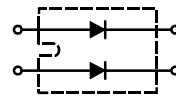


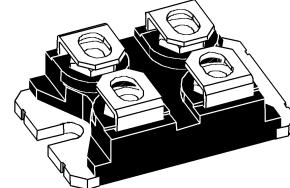
## Power Schottky Rectifier

$I_{FAV} = 2 \times 60 \text{ A}$   
 $V_{RRM} = 45 \text{ V}$   
 $V_F = 0.66 \text{ V}$

$V_{RSM}$ V	$V_{RRM}$ V	Type
45	45	DSS 2x61-0045A



miniBLOC, SOT-227 B



Symbol	Conditions	Maximum Ratings		
$I_{FRMS}$		100	A	
$I_{FAVM}$	$T_C = 105^\circ\text{C}$ ; rectangular, $d = 0.5$	60	A	
$I_{FAVM}$	$T_C = 105^\circ\text{C}$ ; rectangular, $d = 0.5$ ; per device	120	A	
$I_{FSM}$	$T_{VJ} = 45^\circ\text{C}$ ; $t_p = 10 \text{ ms}$ (50 Hz), sine	800	A	
$E_{AS}$	$I_{AS} = 20 \text{ A}$ ; $L = 180 \mu\text{H}$ ; $T_{VJ} = 25^\circ\text{C}$ ; non repetitive	57	mJ	
$I_{AR}$	$V_A = 1.5 \cdot V_{RRM}$ typ.; $f=10 \text{ kHz}$ ; repetitive	2	A	
$(dv/dt)_{cr}$		1000	$\text{V}/\mu\text{s}$	
$T_{VJ}$		-40...+150	$^\circ\text{C}$	
$T_{VJM}$		150	$^\circ\text{C}$	
$T_{stg}$		-40...+150	$^\circ\text{C}$	
$P_{tot}$	$T_C = 25^\circ\text{C}$	150	W	
$V_{ISOL}$	50/60 Hz, RMS $I_{ISOL} \leq 1 \text{ mA}$	2500	V~	
$M_d$	mounting torque (M4) terminal connection torque (M4)	1.1-1.5/9-13 1.1-1.5/9-13	Nm/lb.in. Nm/lb.in.	
Weight	typical	30	g	

Symbol	Conditions	Characteristic Values	
		typ.	max.
$I_R$	① $T_{VJ} = 25^\circ\text{C}$ $V_R = V_{RRM}$ $T_{VJ} = 125^\circ\text{C}$ $V_R = V_{RRM}$	2 20	mA mA
$V_F$	$I_F = 60 \text{ A}; T_{VJ} = 125^\circ\text{C}$ $I_F = 60 \text{ A}; T_{VJ} = 25^\circ\text{C}$ $I_F = 120 \text{ A}; T_{VJ} = 125^\circ\text{C}$	0.66 0.74 0.86	V V V
$R_{thJC}$ $R_{thCH}$		0.1	K/W K/W

Pulse test: ① Pulse Width = 5 ms, Duty Cycle < 2.0 %  
Data according to IEC 60747 and per diode unless otherwise specified

IXYS reserves the right to change limits, Conditions and dimensions.

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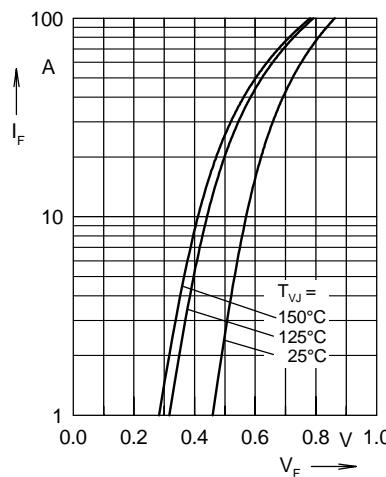


Fig. 1 Maximum forward voltage drop characteristics

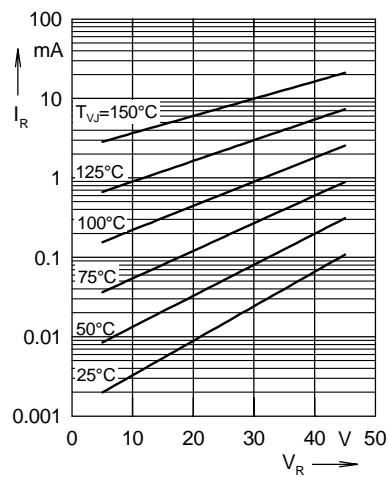


Fig. 2 Typ. value of reverse current  $I_R$  versus reverse voltage  $V_R$

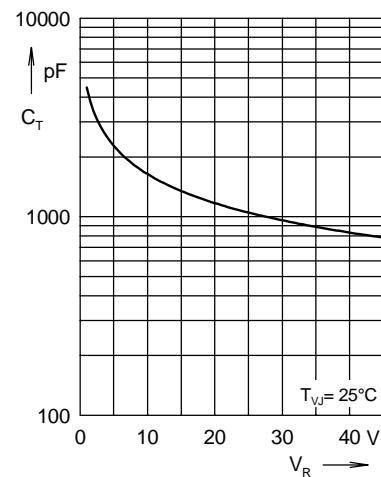


Fig. 3 Typ. junction capacitance  $C_T$  versus reverse voltage  $V_R$

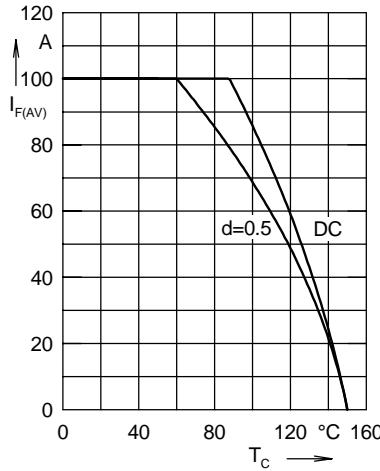


Fig. 4 Average forward current  $I_{F(AV)}$  versus case temperature  $T_C$

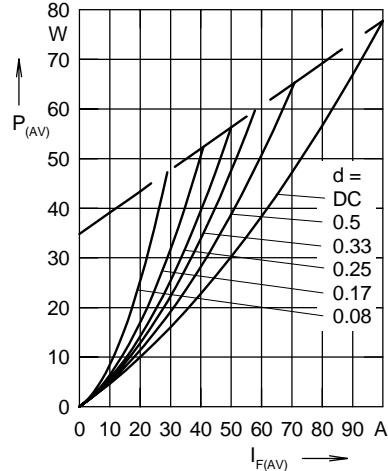


Fig. 5 Forward power loss characteristics

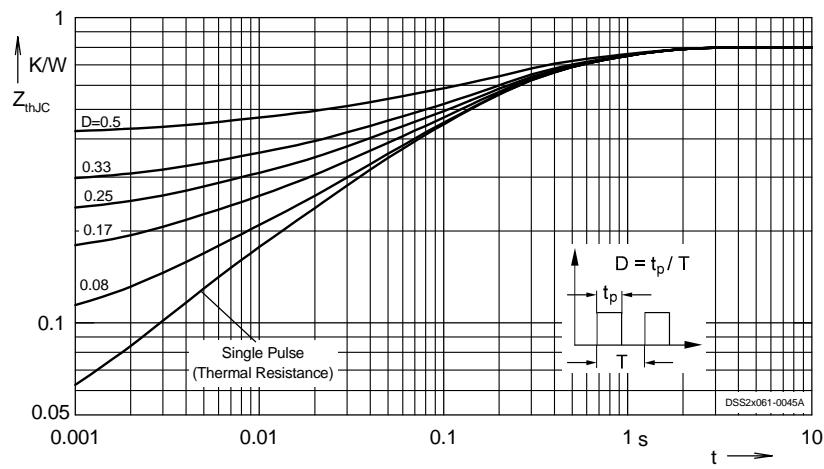


Fig. 6 Transient thermal impedance junction to case at various duty cycles

Note: All curves are per diode